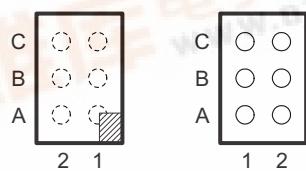


## LOW INPUT VOLTAGE, ULTRA-LOW $r_{ON}$ LOAD SWITCHES

### FEATURES

- Input Voltage: 0.9 V to 3.6 V
- Ultra-Low ON Resistance
  - $r_{ON} = 14 \text{ m}\Omega$  at  $V_{IN} = 3.6 \text{ V}$
  - $r_{ON} = 20 \text{ m}\Omega$  at  $V_{IN} = 2.5 \text{ V}$
  - $r_{ON} = 33 \text{ m}\Omega$  at  $V_{IN} = 1.8 \text{ V}$
  - $r_{ON} = 67 \text{ m}\Omega$  at  $V_{IN} = 1.2 \text{ V}$
  - $r_{ON} = 116 \text{ m}\Omega$  at  $V_{IN} = 1.0 \text{ V}$
- 2-A Maximum Continuous Switch Current
- Ultra-Low Quiescent Current: 78 nA at 1.8 V
- Ultra-Low Shutdown Current: 35 nA at 1.8 V
- Low Threshold Control Input Enable the use of 1.2V/1.8V/2.5V/3.3V Logic
- Controlled Slew Rate to Avoid Inrush Currents
  - TPS22921 and TPS22922: 30  $\mu\text{s}$
  - TPS22922B: 200  $\mu\text{s}$
- ESD Performance Tested Per JESD 22
  - 3000-V Human-Body Model (A114-B, Class II)
  - 1000-V Charged-Device Model (C101)
- Six Terminal Wafer-Chip-Scale Package
  - 0.9 mm x 1.4 mm, 0.5 mm Pitch, 0.5 mm Height
  - 0.8 mm x 1.2 mm, 0.4 mm Pitch, 0.5 mm Height

### YFP, YZP, AND YZT PACKAGES



Laser Marking View      Bump View

	$r_{ON}$ AT 1.8 V (TYP)	SLEW RATE (TYP at 1.8V)	QUICK OUTPUT DISCHARGE <sup>(1)</sup>	MAX OUTPUT CURRENT	ENABLE
TPS22921	33 m $\Omega$	30 $\mu\text{s}$		2 A	active high
TPS22922	33 m $\Omega$	30 $\mu\text{s}$	Yes	2 A	active high
TPS22922B	33 m $\Omega$	200 $\mu\text{s}$	Yes	2 A	active high

(1) This feature discharges the output of the switch to ground through a 120- $\Omega$  resistor, preventing the output from floating.

### APPLICATIONS

- PDAs
- Cell Phones
- GPS Devices
- MP3 Players
- Peripheral Ports
- Portable Media Players
- RF Modules

### DESCRIPTION

TPS22921, TPS22922, and TPS22922B are ultra-low  $r_{ON}$  load switches with controlled turn on. TPS22921/2/2B contain an ultra-low  $r_{ON}$  P-channel MOSFET that can operate over an input voltage range of 0.9 V to 3.6 V. The switch is controlled by an on/off input (ON), which is capable of interfacing directly with low-voltage control signals. In TPS22922 and in TPS22922B, a 120- $\Omega$  on-chip load resistor is added for output quick discharge when switch is turned off. The rise time (slew rate) of the device is internally controlled in order to avoid inrush current: TPS22921 and TPS22922 feature a 30  $\mu\text{s}$  rise time whereas TPS22922B is 200  $\mu\text{s}$ .

TPS22921, TPS22922, and TPS22922B feature ultra low quiescent and shutdown current and are available in space-saving 6-terminals wafer-chip-scale packages (WCSP: YZP with 0.5-mm pitch and YFP with 0.4-mm pitch) which make it ideal for portable electronics. The devices are characterized for operation over the free-air temperature range of -40°C to 85°C.

### TERMINAL ASSIGNMENTS

C	ON	GND
B	$V_{IN}$	$V_{OUT}$
A	$V_{IN}$	$V_{OUT}$
	2	1



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

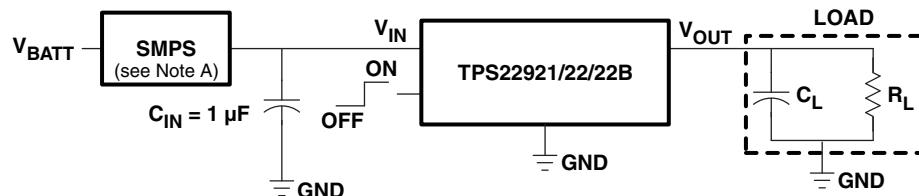
查询 TPS22921 供应商

## ORDERING INFORMATION

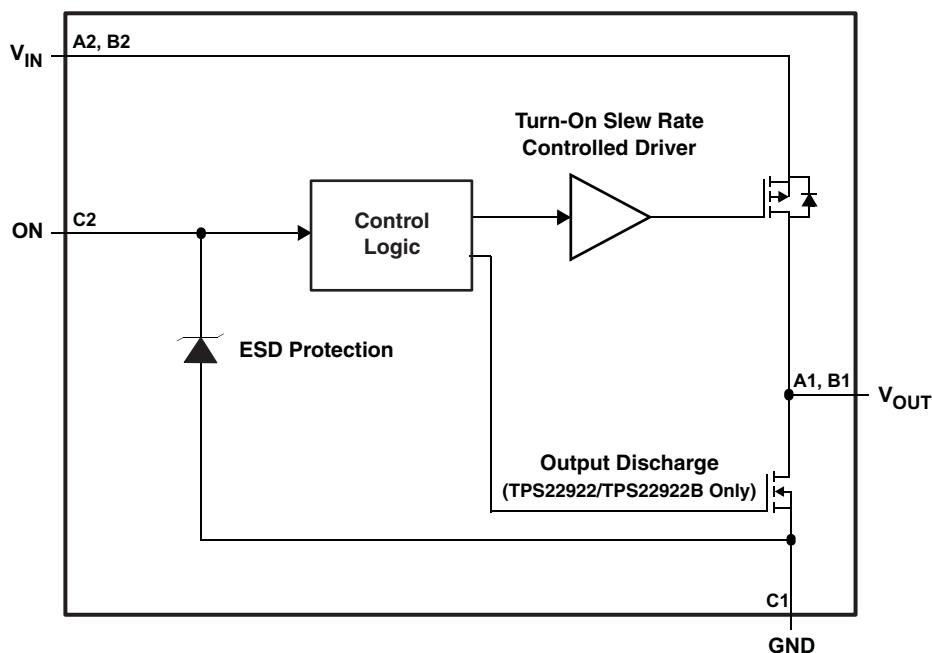
T <sub>A</sub>	PACKAGE <sup>(1)(2)</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 85°C	WCSP – YFP (0.4 mm pitch)	Tape and reel	TPS22921YFPR	_3Y_
			TPS22922YFPR	_2Z_
			TPS22922BYFPR	PREVIEW
	WCSP – YZP (0.5 mm pitch)	Tape and reel	TPS22921YZPR	_3Y_
			TPS22922YZPR	_2Z_
			TPS22922BYZPR	_3Z_
	WCSP – YZT (0.5 mm pitch)	Tape and reel	TPS22921YZTR	_3Y_

(1) Package drawings, thermal data, and symbolization are available at [www.ti.com/packaging](http://www.ti.com/packaging).(2) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at [www.ti.com](http://www.ti.com).

## TYPICAL APPLICATION



A. Switched mode power supply

**APPLICATION BLOCK DIAGRAM**

**Figure 1. Functional Block Diagram**
**FUNCTION TABLE**

ON	V <sub>IN</sub> TO V <sub>OUT</sub>	V <sub>OUT</sub> TO GND <sup>(1)</sup>
L	OFF	ON
H	ON	OFF

(1) TPS22922/TPS22922B only

**TERMINAL FUNCTIONS**

TERMINAL		DESCRIPTION
NO.	NAME	
A1, B1	V <sub>OUT</sub>	Switch output
A2, B2	V <sub>IN</sub>	Switch input
C1	GND	Ground
C2	ON	Switch control input, active high. Do not leave floating

~~查询 TPS22921 供应商~~**ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>**

		MIN	MAX	UNIT
$V_{IN}$	Input voltage range	-0.3	4	V
$V_{OUT}$	Output voltage range		$V_{IN} + 0.3$	V
$V_{ON}$	Input voltage range	-0.3	4	V
P	Power dissipation at $T_A = 25^\circ\text{C}$		0.645	W
$I_{MAX}$	Maximum continuous switch current		2	A
$T_A$	Operating free-air temperature range	-40	85	$^\circ\text{C}$
$T_{stg}$	Storage temperature range	-65	150	$^\circ\text{C}$
$T_{lead}$	Maximum lead temperature (10-s soldering time)		300	$^\circ\text{C}$
ESD	Electrostatic discharge protection	Human-Body Model (HBM)	3000	V
		Charged Device Model (CDM)	1000	
		Machine Model (MM)	300	

- (1) Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

**THERMAL IMPEDANCE RATINGS**

			UNIT
$\theta_{JA}$	Package thermal impedance <sup>(1)</sup>	YFP package	155
		YZP/YZT package	123

- (1) The package thermal impedance is calculated in accordance with JESD 51-7.

**RECOMMENDED OPERATING CONDITIONS**

		MIN	MAX	UNIT
$V_{IN}$	Input voltage range	0.9	3.6	V
$V_{OUT}$	Output voltage range		$V_{IN}$	
$V_{IH}$	High-level input voltage, ON	0.85	3.6	V
$V_{IL}$	Low-level input voltage, ON		0.4	V
$C_{IN}$	Input capacitor	1 <sup>(1)</sup>		$\mu\text{F}$

- (1) Refer to [Application Information](#).

## ELECTRICAL CHARACTERISTICS

$V_{IN} = 0.9 \text{ V}$  to  $3.6 \text{ V}$ ,  $T_A = -40^\circ\text{C}$  to  $85^\circ\text{C}$  (unless otherwise noted)

PARAMETER		TEST CONDITIONS			$T_A$	MIN	TYP <sup>(1)</sup>	MAX	UNIT
$I_{IN}$	Quiescent current	$I_{OUT} = 0$	$V_{IN} = 1\text{-V}$		Full		30	120	nA
			$V_{IN} = 1.8\text{-V}$		Full		78	235	
			$V_{IN} = 3.6\text{-V}$		Full		200	880	
$I_{IN(OFF)}$	OFF-state supply current	$V_{ON} = \text{GND}$ , $OUT = \text{Open}$	$V_{IN} = 1\text{-V}$		Full		10	210	nA
			$V_{IN} = 1.8\text{-V}$		Full		35	260	
			$V_{IN} = 3.6\text{-V}$		Full		120	700	
$I_{IN(LEAKAGE)}$	OFF-state switch current	$V_{ON} = \text{GND}$ , $V_{OUT} = 0$	$V_{IN} = 1\text{-V}$		Full		12	140	nA
			$V_{IN} = 1.8\text{-V}$		Full		50	230	
			$V_{IN} = 3.6\text{-V}$		Full		130	610	
$r_{ON}$	ON-state resistance	$I_{OUT} = -200 \text{ mA}$	$V_{IN} = 3.6 \text{ V}$		25°C		14	45	mΩ
			Full				50		
			$V_{IN} = 2.5 \text{ V}$		25°C		20	55	
			Full				60		
			$V_{IN} = 1.8 \text{ V}$		25°C		33	65	
			Full				75		
			$V_{IN} = 1.2 \text{ V}$		25°C		67	100	
			Full				120		
			$V_{IN} = 1.1 \text{ V}$		25°C		82	150	
			Full				160		
			$V_{IN} = 1.0 \text{ V}$		25°C		116	160	
			Full				170		
$r_{PD}$	Output pulldown resistance	$V_{IN} = 3.3 \text{ V}$ , $V_{ON} = 0$ , $I_{OUT} = 30 \text{ mA}$ (TPS22922/TPS22922B only)			25°C		65	120	Ω
$I_{ON}$	ON input leakage current	$V_{ON} = 1.1 \text{ V}$ to $3.6 \text{ V}$ or GND			Full			25	nA

(1) Typical values are at the specified  $V_{IN}$  and  $T_A = 25^\circ\text{C}$ .

## SWITCHING CHARACTERISTICS

$V_{IN} = 0.9 \text{ V}$ ,  $T_A = 25^\circ\text{C}$  (unless otherwise noted)

PARAMETER	TEST CONDITIONS	TPS22921			TPS22922 <sup>(1)</sup>			TPS22922B <sup>(1)</sup>			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
$t_{ON}$	Turn-ON time	$R_L = 500 \Omega$	$C_L = 0.1 \mu\text{F}$	121		121		638			μs
			$C_L = 1 \mu\text{F}$	160		160		712			
			$C_L = 3 \mu\text{F}$	188		188		799			
$t_{OFF}$	Turn-OFF time	$R_L = 500 \Omega$	$C_L = 0.1 \mu\text{F}$	46		40		40			μs
			$C_L = 1 \mu\text{F}$	308		279		279			
			$C_L = 3 \mu\text{F}$	975		807		807			
$t_r$	$V_{OUT}$ rise time	$R_L = 500 \Omega$	$C_L = 0.1 \mu\text{F}$	60		60		462			μs
			$C_L = 1 \mu\text{F}$	85		85		465			
			$C_L = 3 \mu\text{F}$	107		107		507			
$t_f$	$V_{OUT}$ fall time	$R_L = 500 \Omega$	$C_L = 0.1 \mu\text{F}$	119		51		51			μs
			$C_L = 1 \mu\text{F}$	969		434		434			
			$C_L = 3 \mu\text{F}$	3174		1264		1264			

(1)  $RL\_CHIP = 120 \Omega$

~~查询 TPS22921 供应商~~**SWITCHING CHARACTERISTICS** $V_{IN} = 1.0 \text{ V}$ ,  $T_A = 25^\circ\text{C}$  (unless otherwise noted)

PARAMETER	TEST CONDITIONS	TPS22921			TPS22922 <sup>(1)</sup>			TPS22922B <sup>(1)</sup>			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
$t_{ON}$ Turn-ON time	$R_L = 500 \Omega$ ,	$C_L = 0.1 \mu\text{F}$	105		105			549			$\mu\text{s}$
		$C_L = 1 \mu\text{F}$	136		136			613			
		$C_L = 3 \mu\text{F}$	157		157			683			
$t_{OFF}$ Turn-OFF time	$R_L = 500 \Omega$ ,	$C_L = 0.1 \mu\text{F}$	46		28			28			$\mu\text{s}$
		$C_L = 1 \mu\text{F}$	309		186			186			
		$C_L = 3 \mu\text{F}$	983		511			511			
$t_r$ $V_{OUT}$ rise time	$R_L = 500 \Omega$ ,	$C_L = 0.1 \mu\text{F}$	51		51			386			$\mu\text{s}$
		$C_L = 1 \mu\text{F}$	78		78			388			
		$C_L = 3 \mu\text{F}$	88		88			419			
$t_f$ $V_{OUT}$ fall time	$R_L = 500 \Omega$ ,	$C_L = 0.1 \mu\text{F}$	121		34			34			$\mu\text{s}$
		$C_L = 1 \mu\text{F}$	986		306			306			
		$C_L = 3 \mu\text{F}$	3300		908			908			

(1)  $RL\_CHIP = 120 \Omega$ **SWITCHING CHARACTERISTICS** $V_{IN} = 1.1 \text{ V}$ ,  $T_A = 25^\circ\text{C}$  (unless otherwise noted)

PARAMETER	TEST CONDITIONS	TPS22921			TPS22922 <sup>(1)</sup>			TPS22922B <sup>(1)</sup>			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
$t_{ON}$ Turn-ON time	$R_L = 500 \Omega$ ,	$C_L = 0.1 \mu\text{F}$	91		93			484			$\mu\text{s}$
		$C_L = 1 \mu\text{F}$	118		118			540			
		$C_L = 3 \mu\text{F}$	137		137			599			
$t_{OFF}$ Turn-OFF time	$R_L = 500 \Omega$ ,	$C_L = 0.1 \mu\text{F}$	44		21			21			$\mu\text{s}$
		$C_L = 1 \mu\text{F}$	311		144			144			
		$C_L = 3 \mu\text{F}$	99		383			383			
$t_r$ $V_{OUT}$ rise time	$R_L = 500 \Omega$ ,	$C_L = 0.1 \mu\text{F}$	46		46			335			$\mu\text{s}$
		$C_L = 1 \mu\text{F}$	60		60			336			
		$C_L = 3 \mu\text{F}$	76		76			363			
$t_f$ $V_{OUT}$ fall time	$R_L = 500 \Omega$ ,	$C_L = 0.1 \mu\text{F}$	122		29			29			$\mu\text{s}$
		$C_L = 1 \mu\text{F}$	1000		224			224			
		$C_L = 3 \mu\text{F}$	3300		732			732			

(1)  $RL\_CHIP = 120 \Omega$

## SWITCHING CHARACTERISTICS

$V_{IN} = 1.2 \text{ V}$ ,  $T_A = 25^\circ\text{C}$  (unless otherwise noted)

PARAMETER	TEST CONDITIONS	TPS22921			TPS22922 <sup>(1)</sup>			TPS22922B <sup>(1)</sup>			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
$t_{ON}$ Turn-ON time	$R_L = 500 \Omega$ ,	$C_L = 0.1 \mu\text{F}$	83		83			435			$\mu\text{s}$
		$C_L = 1 \mu\text{F}$	103		103			485			
		$C_L = 3 \mu\text{F}$	122		122			536			
$t_{OFF}$ Turn-OFF time	$R_L = 500 \Omega$ ,	$C_L = 0.1 \mu\text{F}$	44		17			17			$\mu\text{s}$
		$C_L = 1 \mu\text{F}$	312		117			117			
		$C_L = 3 \mu\text{F}$	1000		319			319			
$t_r$ $V_{OUT}$ rise time	$R_L = 500 \Omega$ ,	$C_L = 0.1 \mu\text{F}$	41		41			301			$\mu\text{s}$
		$C_L = 1 \mu\text{F}$	54		54			302			
		$C_L = 3 \mu\text{F}$	67		67			325			
$t_f$ $V_{OUT}$ fall time	$R_L = 500 \Omega$ ,	$C_L = 0.1 \mu\text{F}$	123		25			25			$\mu\text{s}$
		$C_L = 1 \mu\text{F}$	1000		214			214			
		$C_L = 3 \mu\text{F}$	3400		632			632			

(1)  $R_{L\_CHIP} = 120 \Omega$

## SWITCHING CHARACTERISTICS

$V_{IN} = 1.8 \text{ V}$ ,  $T_A = 25^\circ\text{C}$  (unless otherwise noted)

PARAMETER	TEST CONDITIONS	TPS22921			TPS22922 <sup>(1)</sup>			TPS22922B <sup>(1)</sup>			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
$t_{ON}$ Turn-ON time	$R_L = 500 \Omega$ ,	$C_L = 0.1 \mu\text{F}$	54		54			282			$\mu\text{s}$
		$C_L = 1 \mu\text{F}$	67		67			314			
		$C_L = 3 \mu\text{F}$	78		78			344			
$t_{OFF}$ Turn-OFF time	$R_L = 500 \Omega$ ,	$C_L = 0.1 \mu\text{F}$	41		10			10			$\mu\text{s}$
		$C_L = 1 \mu\text{F}$	312		67			67			
		$C_L = 3 \mu\text{F}$	1000		181			181			
$t_r$ $V_{OUT}$ rise time	$R_L = 500 \Omega$ ,	$C_L = 0.1 \mu\text{F}$	30		30			200			$\mu\text{s}$
		$C_L = 1 \mu\text{F}$	37		37			202			
		$C_L = 3 \mu\text{F}$	47		47			219			
$t_f$ $V_{OUT}$ fall time	$R_L = 500 \Omega$ ,	$C_L = 0.1 \mu\text{F}$	121		17			17			$\mu\text{s}$
		$C_L = 1 \mu\text{F}$	1000		158			158			
		$C_L = 3 \mu\text{F}$	3450		461			461			

(1)  $R_{L\_CHIP} = 120 \Omega$

~~查询 TPS22921 供应商~~**SWITCHING CHARACTERISTICS** $V_{IN} = 2.5 \text{ V}$ ,  $T_A = 25^\circ\text{C}$  (unless otherwise noted)

PARAMETER	TEST CONDITIONS	TPS22921			TPS22922 <sup>(1)</sup>			TPS22922B <sup>(1)</sup>			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
$t_{ON}$ Turn-ON time	$R_L = 500 \Omega$ ,	$C_L = 0.1 \mu\text{F}$	40		40			211			$\mu\text{s}$
		$C_L = 1 \mu\text{F}$	50		50			233			
		$C_L = 3 \mu\text{F}$	59		59			256			
$t_{OFF}$ Turn-OFF time	$R_L = 500 \Omega$ ,	$C_L = 0.1 \mu\text{F}$	41		10			10			$\mu\text{s}$
		$C_L = 1 \mu\text{F}$	316		56			56			
		$C_L = 3 \mu\text{F}$	1000		153			153			
$t_r$ $V_{OUT}$ rise time	$R_L = 500 \Omega$ ,	$C_L = 0.1 \mu\text{F}$	23		23			164			$\mu\text{s}$
		$C_L = 1 \mu\text{F}$	29		29			165			
		$C_L = 3 \mu\text{F}$	38		38			177			
$t_f$ $V_{OUT}$ fall time	$R_L = 500 \Omega$ ,	$C_L = 0.1 \mu\text{F}$	122		16			16			$\mu\text{s}$
		$C_L = 1 \mu\text{F}$	1086		147			147			
		$C_L = 3 \mu\text{F}$	3600		430			430			

(1)  $R_{L\_CHIP} = 120 \Omega$ **SWITCHING CHARACTERISTICS** $V_{IN} = 3 \text{ V}$ ,  $T_A = 25^\circ\text{C}$  (unless otherwise noted)

PARAMETER	TEST CONDITIONS	TPS22921			TPS22922 <sup>(1)</sup>			TPS22922B <sup>(1)</sup>			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
$t_{ON}$ Turn-ON time	$R_L = 500 \Omega$ ,	$C_L = 0.1 \mu\text{F}$	30		30			182			$\mu\text{s}$
		$C_L = 1 \mu\text{F}$	38		38			201			
		$C_L = 3 \mu\text{F}$	45		45			221			
$t_{OFF}$ Turn-OFF time	$R_L = 500 \Omega$ ,	$C_L = 0.1 \mu\text{F}$	40		10			10			$\mu\text{s}$
		$C_L = 1 \mu\text{F}$	353		51			51			
		$C_L = 3 \mu\text{F}$	1036		139			139			
$t_r$ $V_{OUT}$ rise time	$R_L = 500 \Omega$ ,	$C_L = 0.1 \mu\text{F}$	20		20			149			$\mu\text{s}$
		$C_L = 1 \mu\text{F}$	25		25			150			
		$C_L = 3 \mu\text{F}$	33		33			161			
$t_f$ $V_{OUT}$ fall time	$R_L = 500 \Omega$ ,	$C_L = 0.1 \mu\text{F}$	104		15			15			$\mu\text{s}$
		$C_L = 1 \mu\text{F}$	1030		143			143			
		$C_L = 3 \mu\text{F}$	3230		419			419			

(1)  $R_{L\_CHIP} = 120 \Omega$

**SWITCHING CHARACTERISTICS**
 $V_{IN} = 3.6 \text{ V}$ ,  $T_A = 25^\circ\text{C}$  (unless otherwise noted)

<b>PARAMETER</b>	<b>TEST CONDITIONS</b>	<b>TPS22921</b>			<b>TPS22922<sup>(1)</sup></b>			<b>TPS22922B<sup>(1)</sup></b>			<b>UNIT</b>
		<b>MIN</b>	<b>TYP</b>	<b>MAX</b>	<b>MIN</b>	<b>TYP</b>	<b>MAX</b>	<b>MIN</b>	<b>TYP</b>	<b>MAX</b>	
$t_{ON}$ Turn-ON time	$R_L = 500 \Omega$ ,	$C_L = 0.1 \mu\text{F}$	30	30	159						$\mu\text{s}$
		$C_L = 1 \mu\text{F}$	38	38	175						
		$C_L = 3 \mu\text{F}$	45	45	193						
$t_{OFF}$ Turn-OFF time	$R_L = 500 \Omega$ ,	$C_L = 0.1 \mu\text{F}$	42	10	10						$\mu\text{s}$
		$C_L = 1 \mu\text{F}$	310	51	51						
		$C_L = 3 \mu\text{F}$	988	139	139						
$t_r$ $V_{OUT}$ rise time	$R_L = 500 \Omega$ ,	$C_L = 0.1 \mu\text{F}$	20	20	137						$\mu\text{s}$
		$C_L = 1 \mu\text{F}$	25	25	138						
		$C_L = 3 \mu\text{F}$	33	33	148						
$t_f$ $V_{OUT}$ fall time	$R_L = 500 \Omega$ ,	$C_L = 0.1 \mu\text{F}$	120	15	15						$\mu\text{s}$
		$C_L = 1 \mu\text{F}$	1100	143	143						
		$C_L = 3 \mu\text{F}$	3600	419	419						

 (1)  $R_{L\_CHIP} = 120 \Omega$

查询 TPS22921 供应商

## TYPICAL CHARACTERISTICS

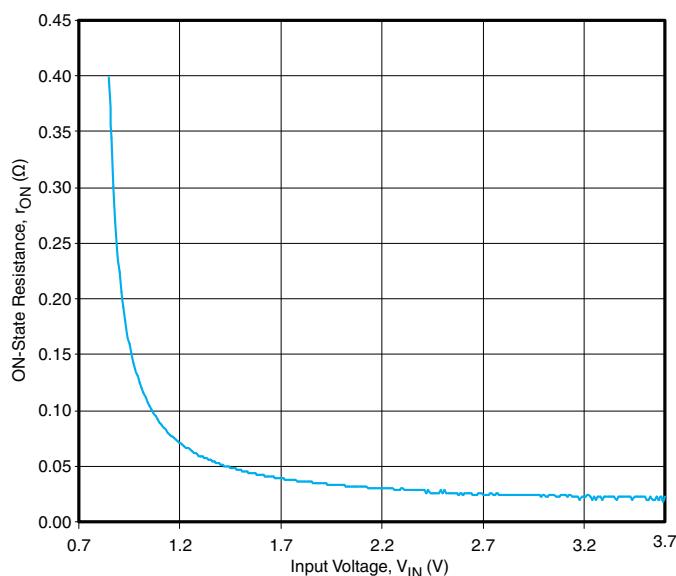
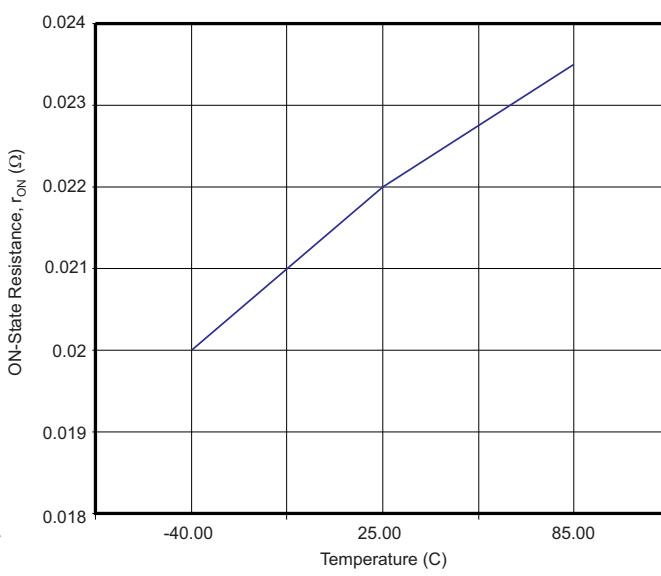
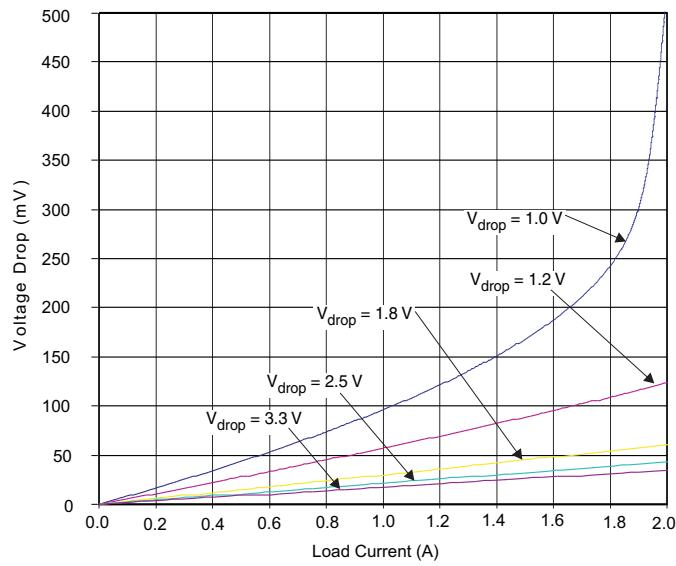
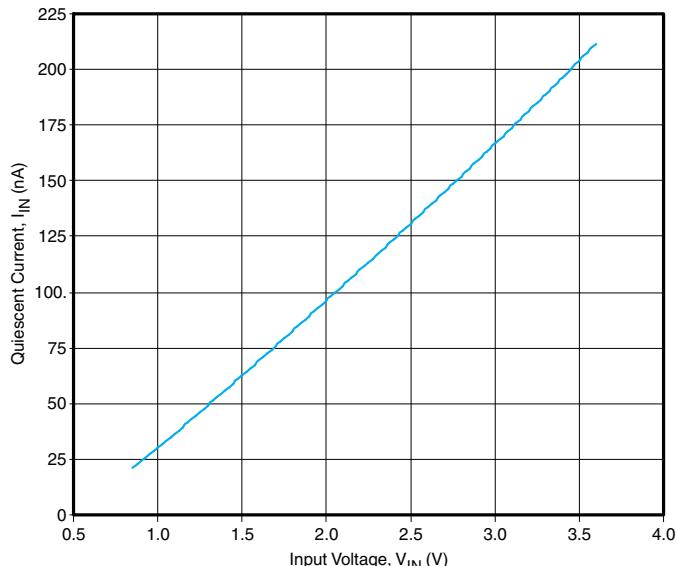
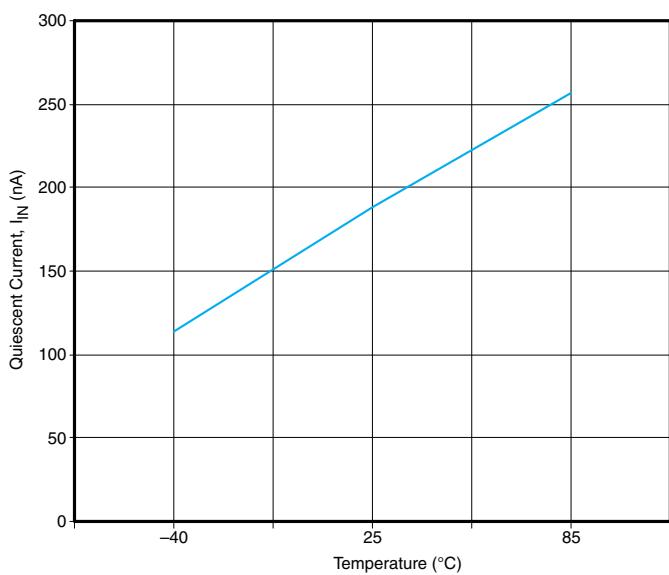
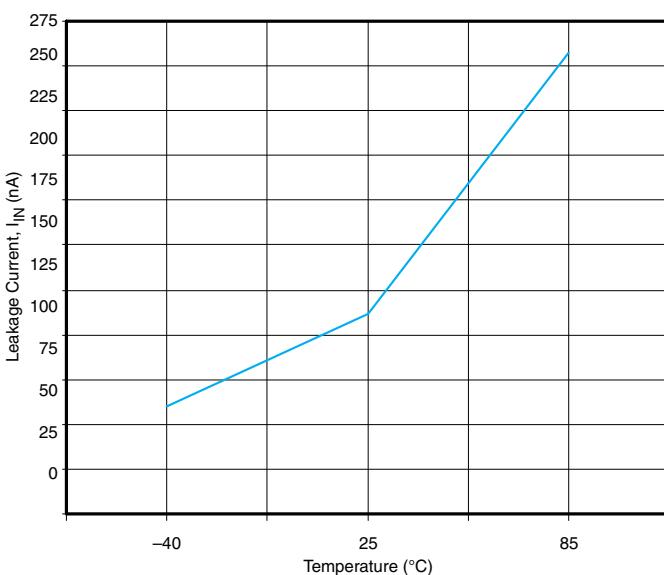
Figure 2.  $r_{ON}$  vs.  $V_{IN}$ Figure 3.  $r_{ON}$  vs. Temperature ( $V_{IN} = 3.3$  V)

Figure 4. Voltage Drop vs Load Current

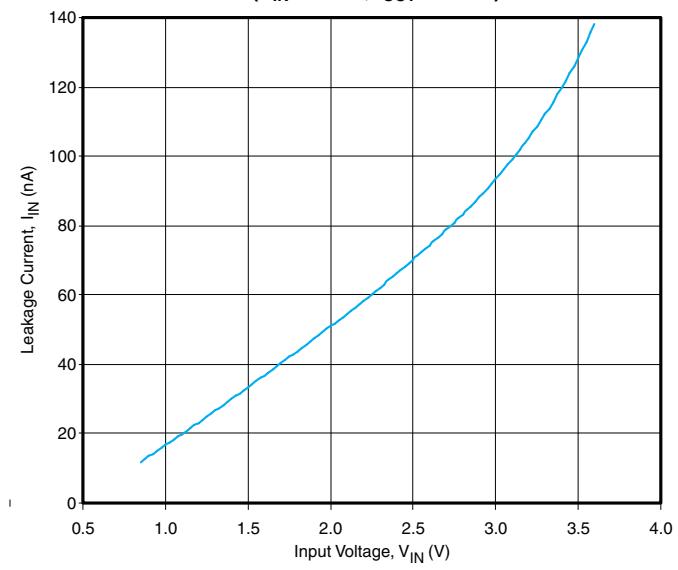
Figure 5. Quiescent Current vs.  $V_{IN}$   
( $V_{ON} = V_{IN}$ )

**TYPICAL CHARACTERISTICS (continued)**


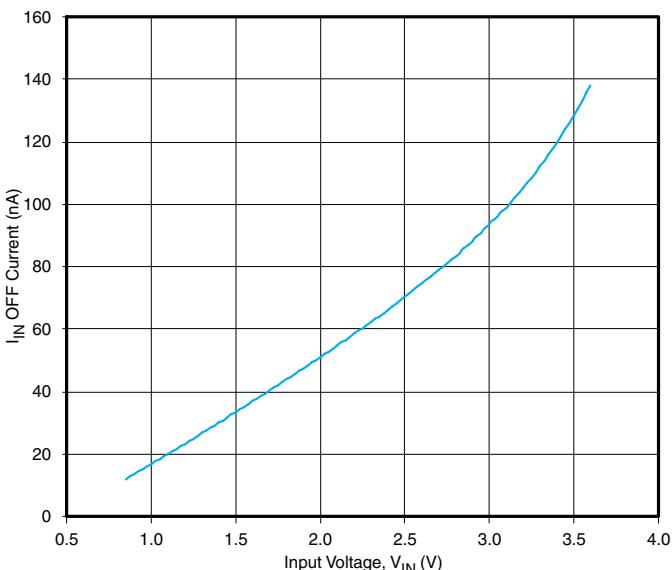
**Figure 6. Quiescent Current vs. Temperature**  
 $(V_{IN} = 3.3 \text{ V}, I_{OUT} = 0 \text{ mA})$



**Figure 7. I<sub>IN</sub> Leakage Current vs. Temperature ( $V_{IN} = 3.3 \text{ V}$ )**



**Figure 8. Leakage Current vs V<sub>IN</sub>**



**Figure 9. I<sub>IN</sub> (OFF) vs V<sub>IN</sub> ( $V_{ON} = 0 \text{ V}$ )**

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## TYPICAL CHARACTERISTICS (continued)

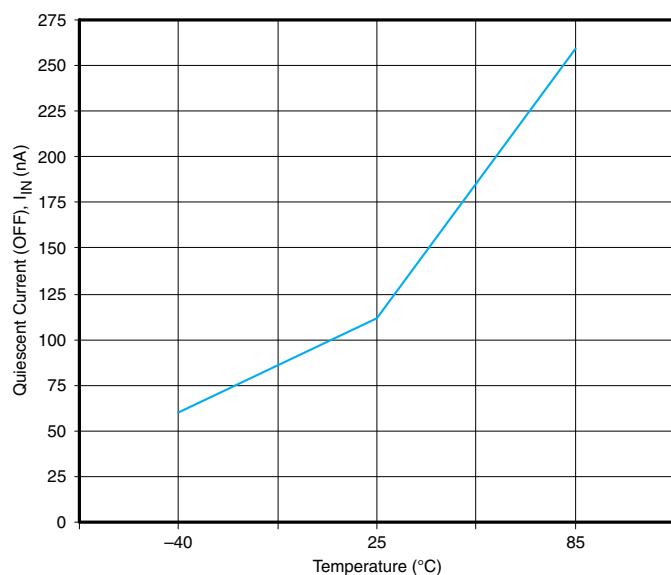
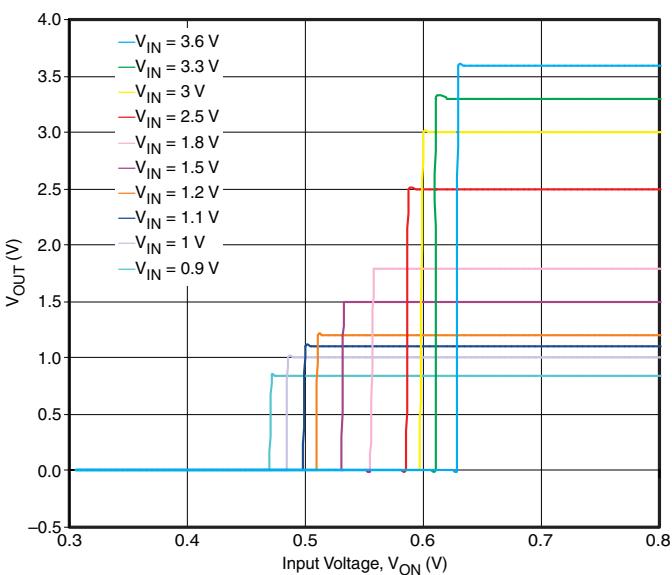
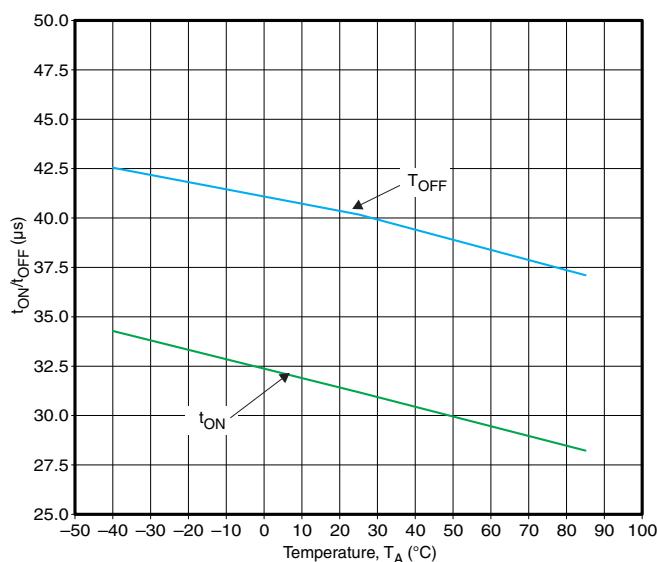
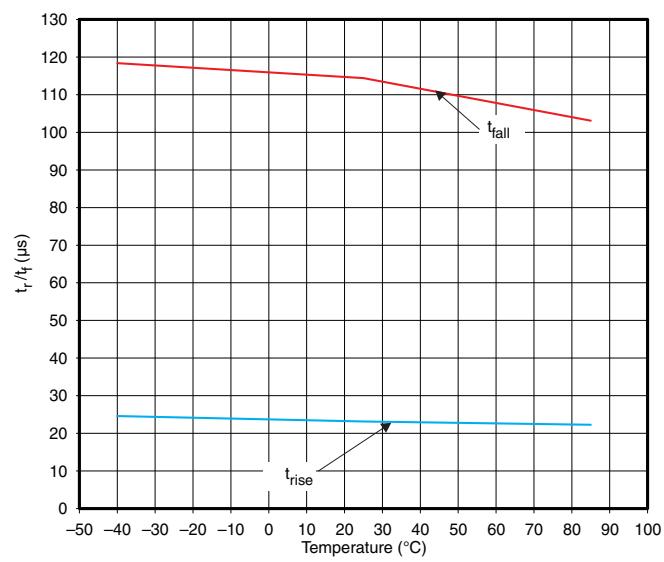
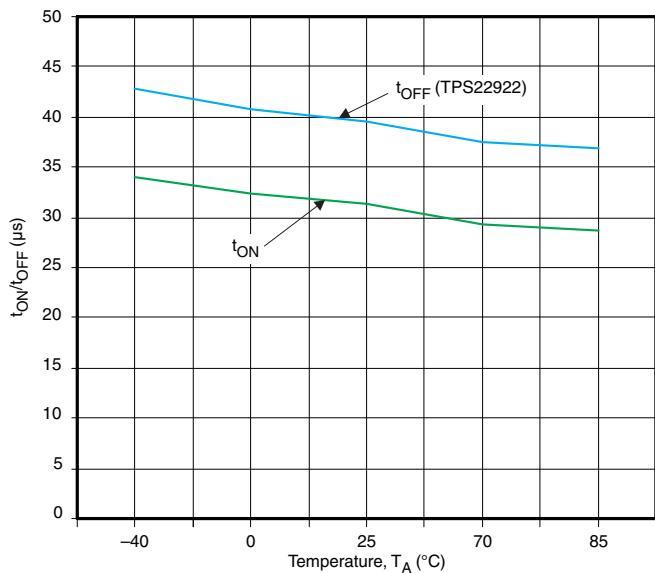
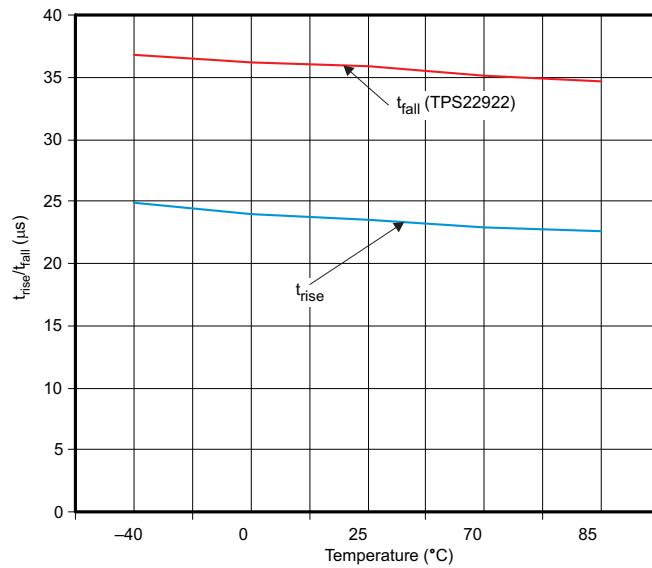
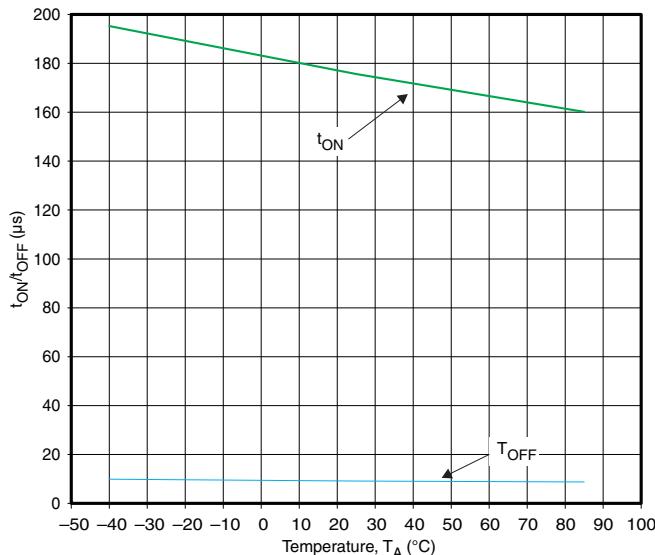
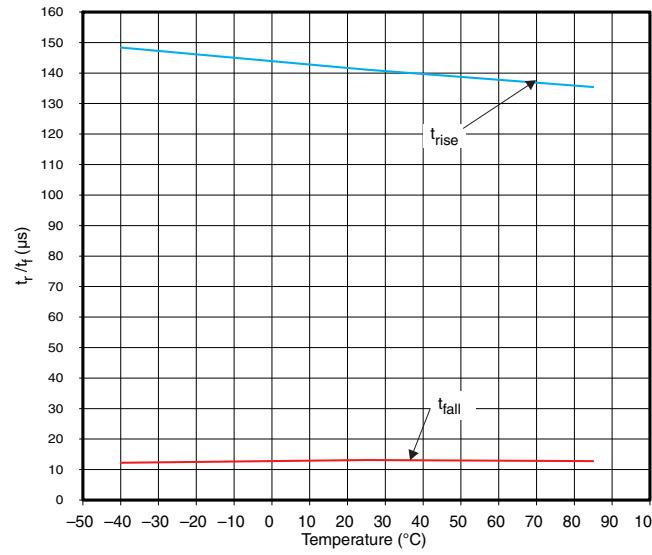
Figure 10.  $I_{IN}$  (OFF) vs Temperature ( $V_{IN} = 3.3$  V)

Figure 11. ON-Input Threshold

## TPS22921

Figure 12.  $t_{ON}/t_{OFF}$  vs Temperature ( $V_{IN} = 3.3$  V)Figure 13.  $t_{rise}/t_{fall}$  vs Temperature ( $V_{IN} = 3.3$  V)

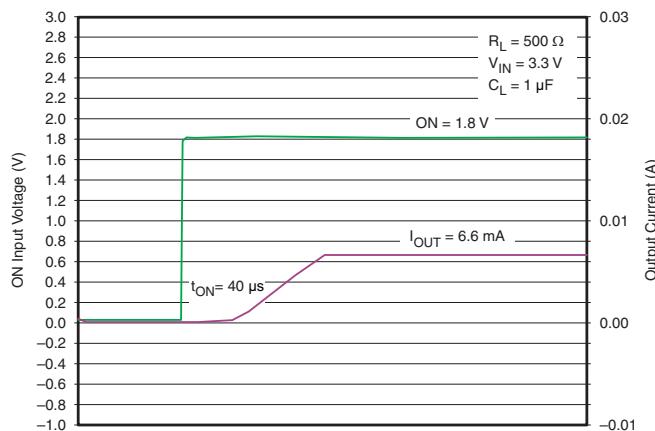
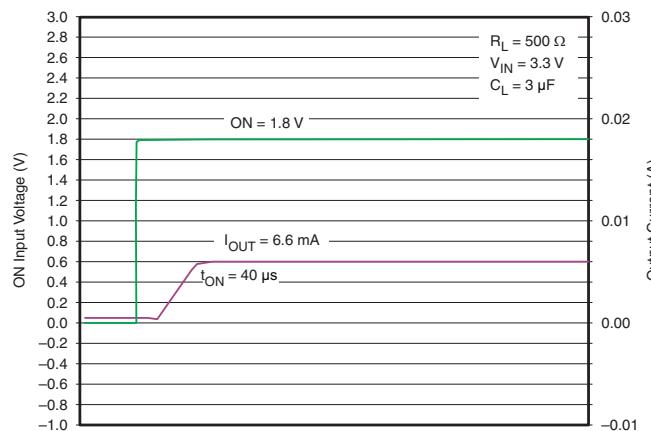
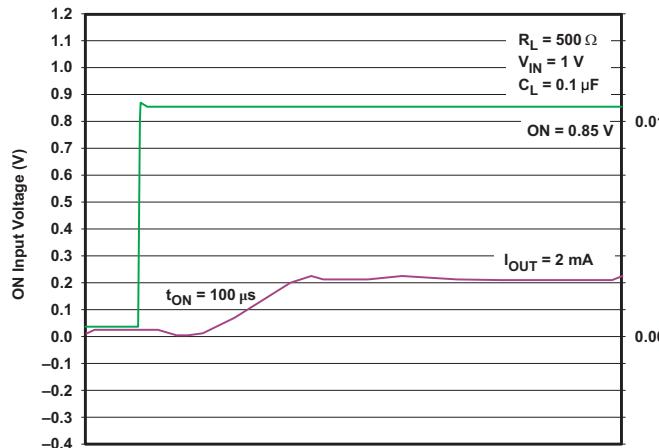
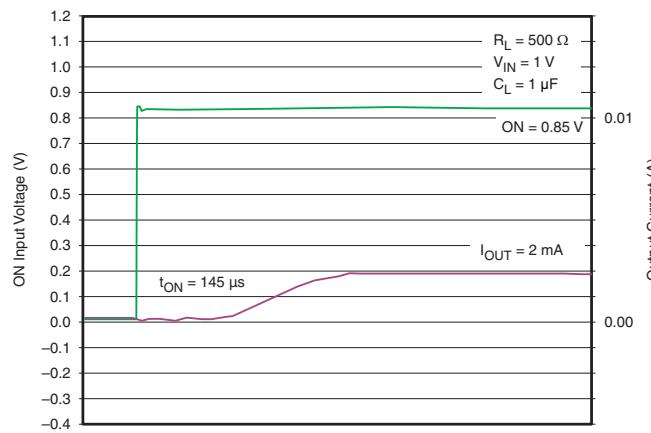
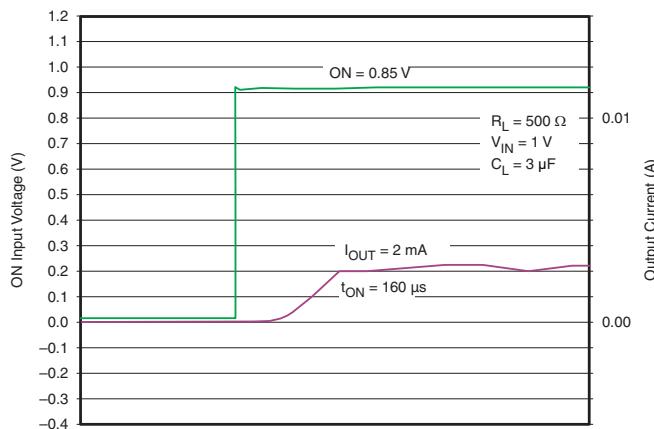
**TYPICAL CHARACTERISTICS (continued)**
**TPS22922**

**Figure 14.**  $t_{ON}/t_{OFF}$  vs Temperature ( $V_{IN} = 3.3$  V)

**Figure 15.**  $t_{rise}/t_{fall}$  vs Temperature ( $V_{IN} = 3.3$  V)

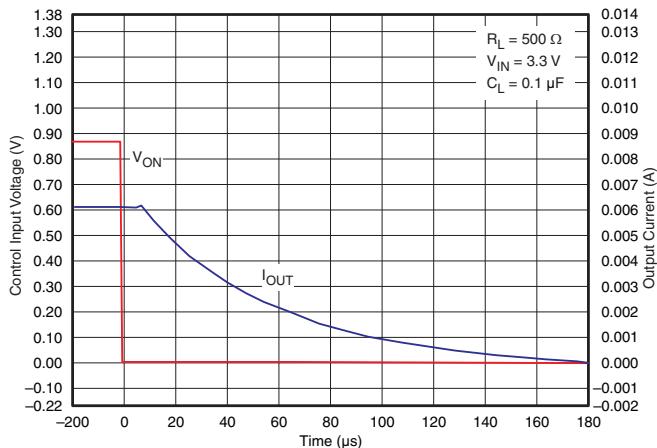
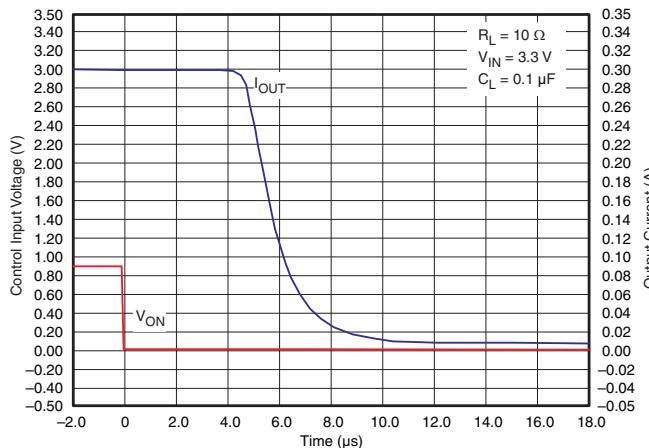
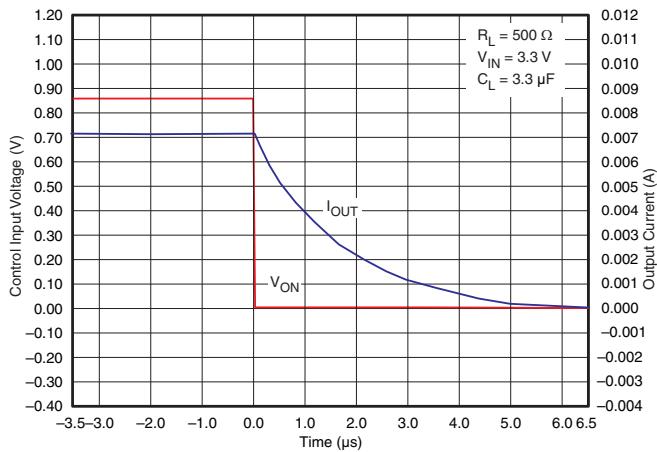
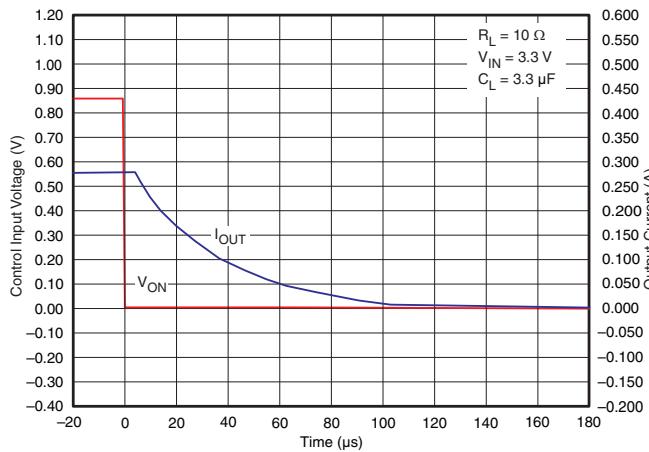
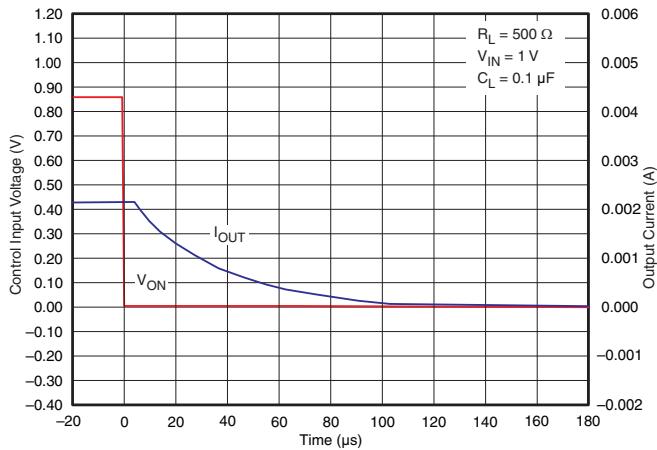
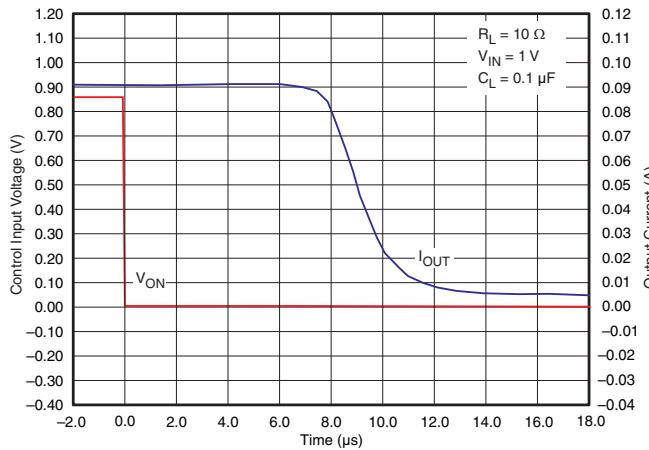
**TPS22922B**

**Figure 16.**  $t_{ON}/t_{OFF}$  vs Temperature ( $V_{IN} = 3.3$  V)

**Figure 17.**  $t_{rise}/t_{fall}$  vs Temperature ( $V_{IN} = 3.3$  V)

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## TYPICAL CHARACTERISTICS (continued)

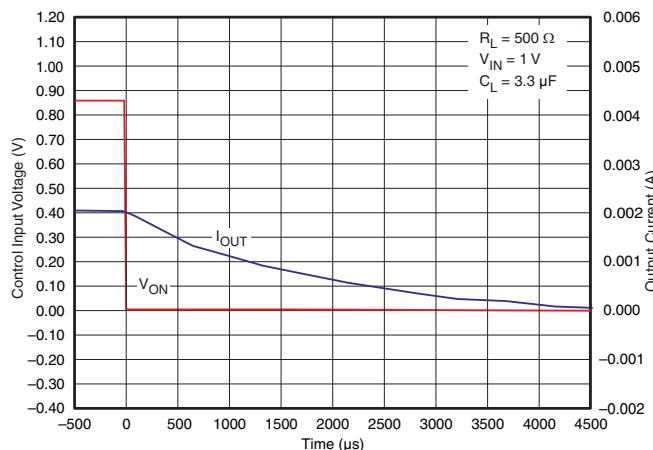
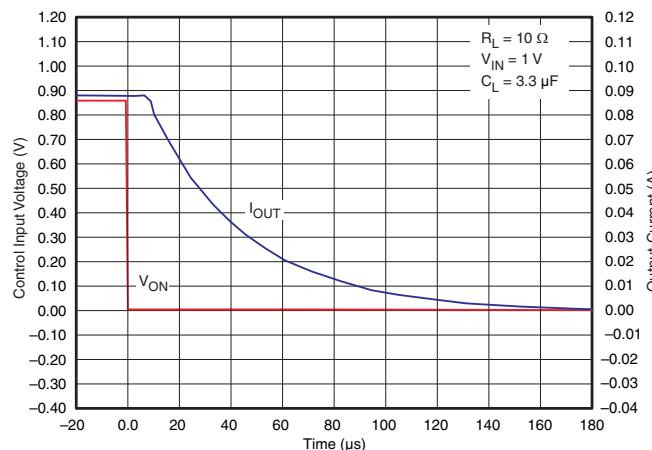
## TPS22921 and TPS22922

Figure 18.  $t_{ON}$  ResponseFigure 19.  $t_{ON}$  ResponseFigure 20.  $t_{ON}$  ResponseFigure 21.  $t_{ON}$  ResponseFigure 22.  $t_{ON}$  Response

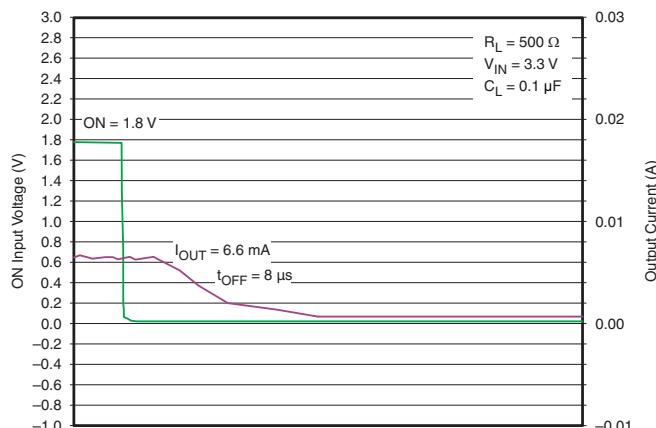
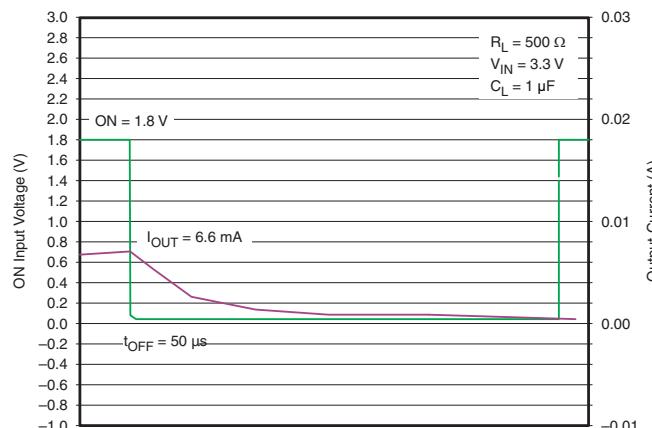
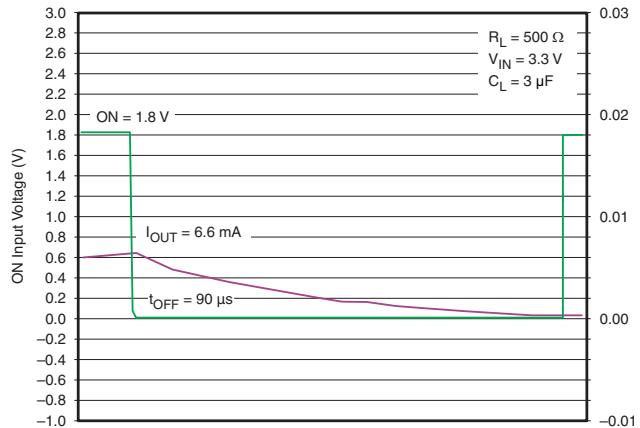
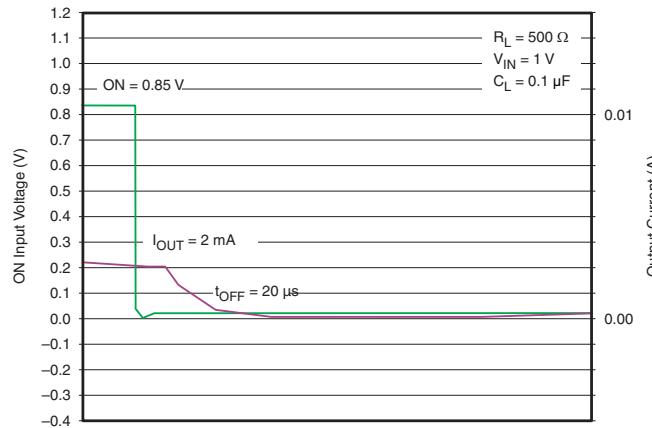
**TYPICAL CHARACTERISTICS (continued)**
**TPS22921**

**Figure 23.  $t_{OFF}$  Response**

**Figure 24.  $t_{OFF}$  Response**

**Figure 25.  $t_{OFF}$  Response**

**Figure 26.  $t_{OFF}$  Response**

**Figure 27.  $t_{OFF}$  Response**

**Figure 28.  $t_{OFF}$  Response**

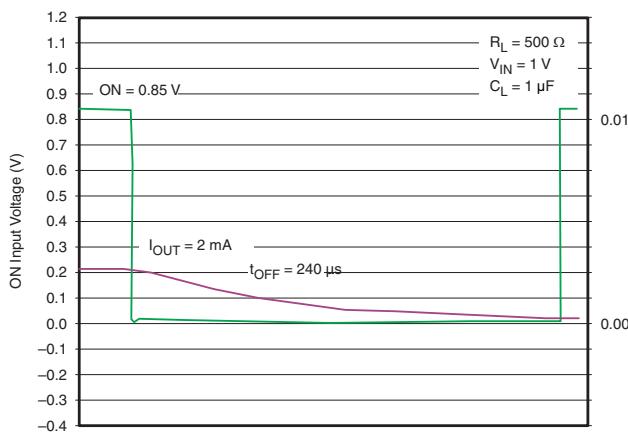
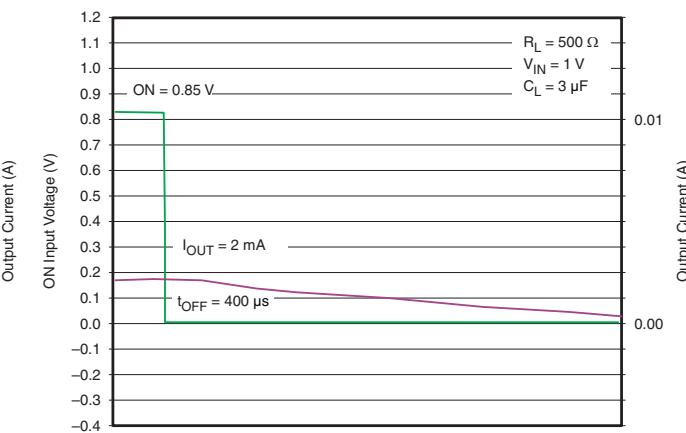
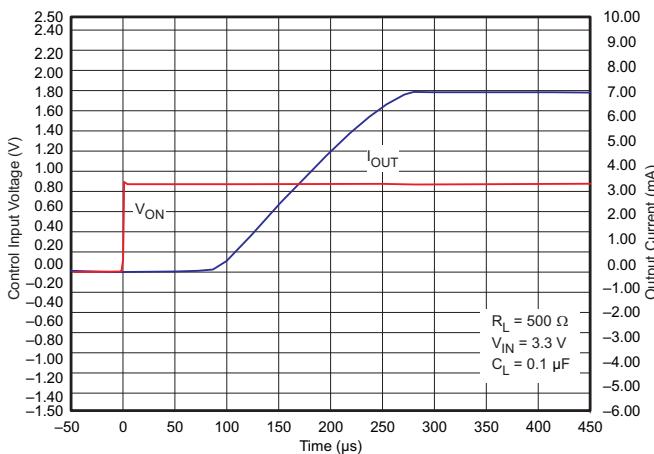
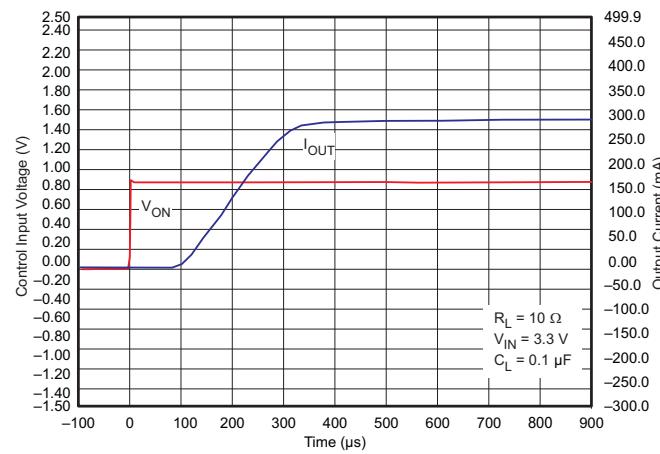
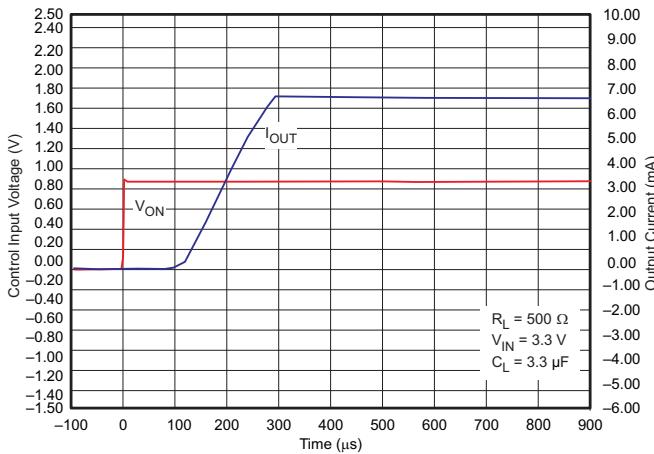
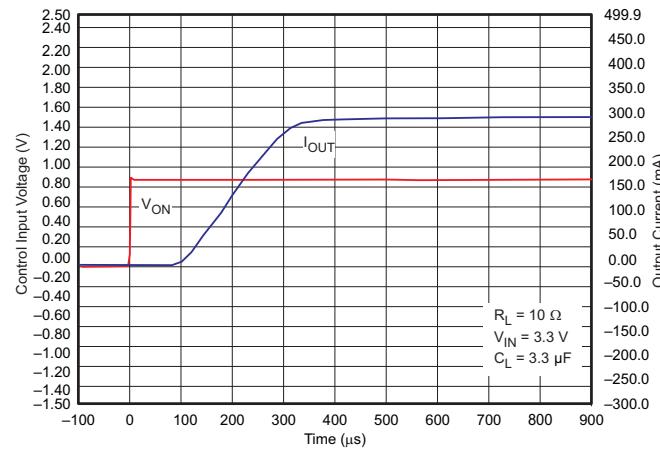
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## TYPICAL CHARACTERISTICS (continued)

Figure 29.  $t_{OFF}$  ResponseFigure 30.  $t_{OFF}$  Response

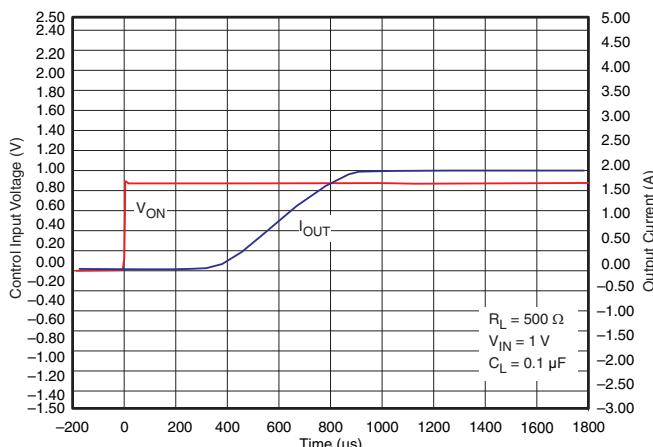
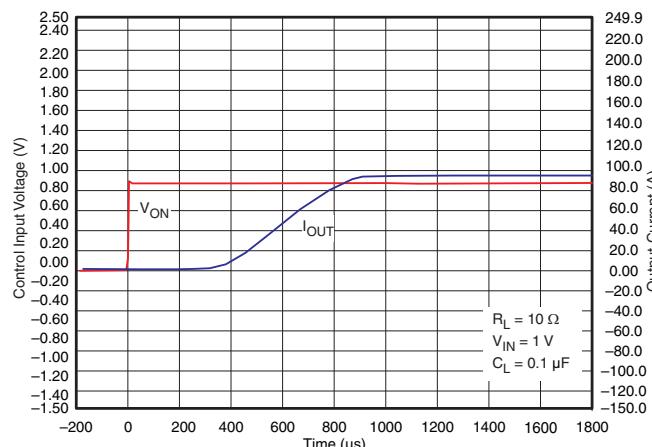
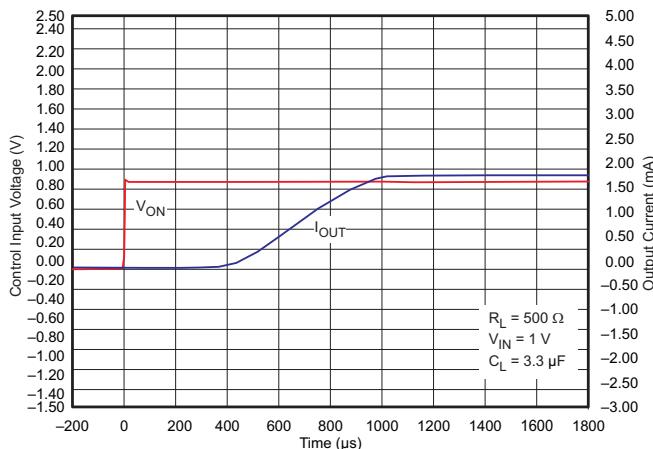
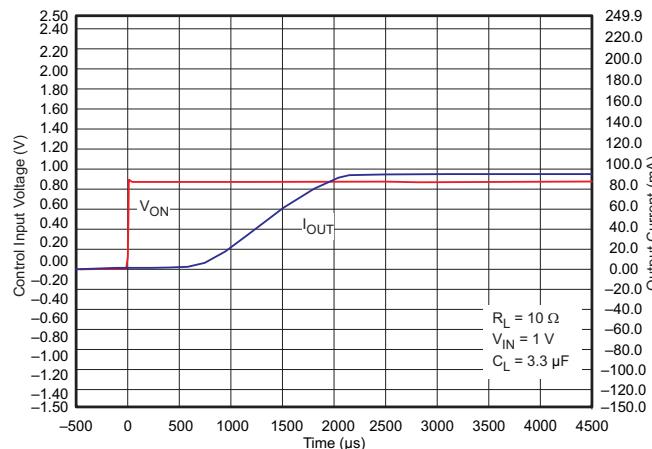
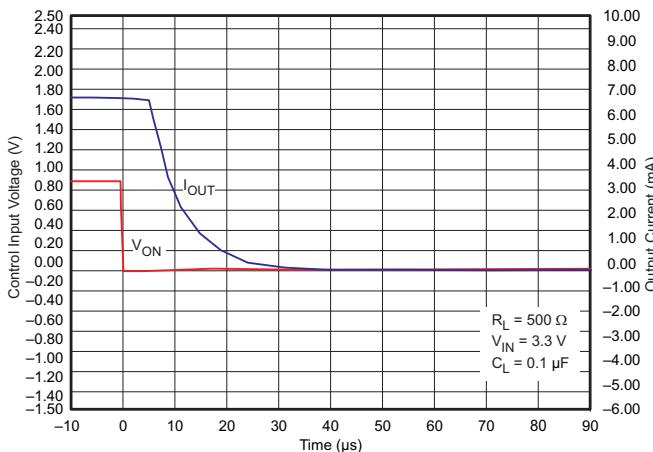
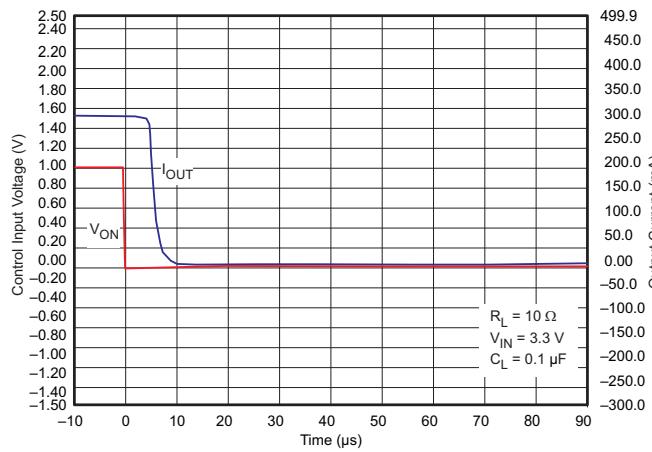
## TPS22922

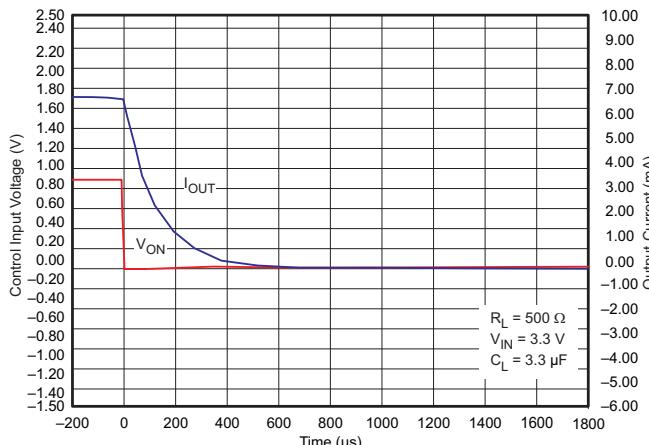
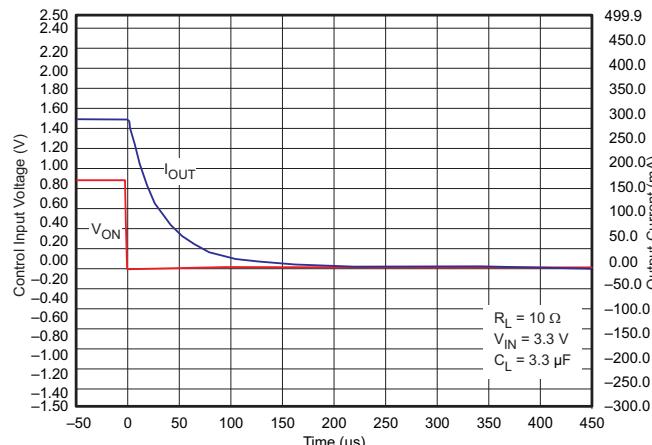
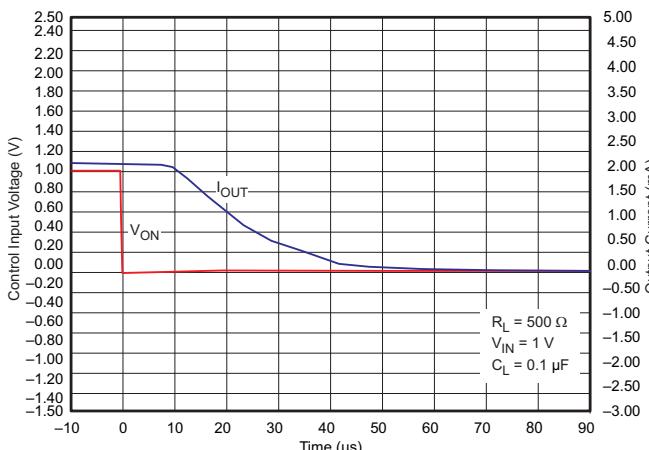
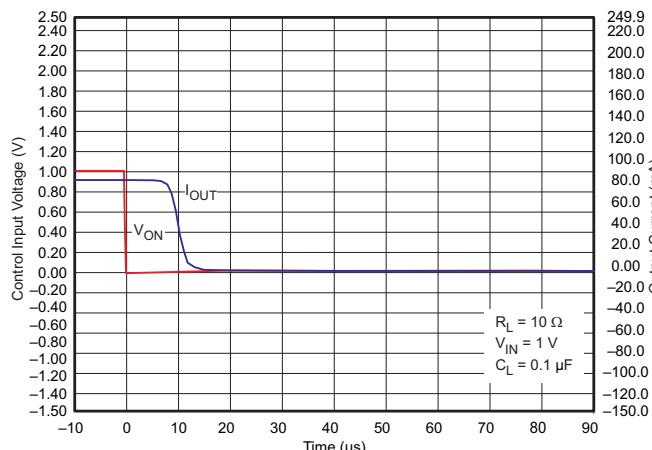
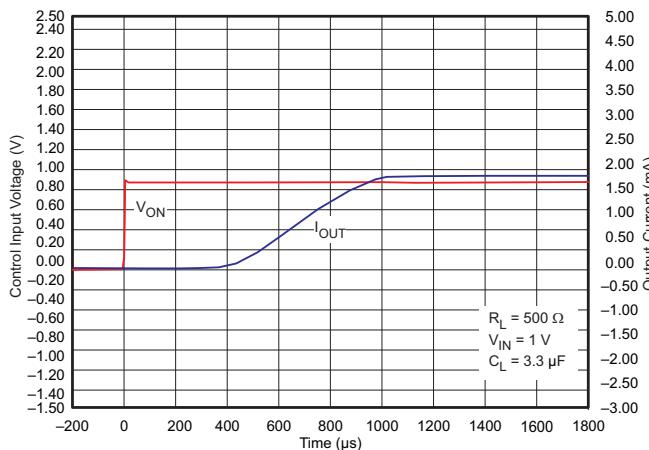
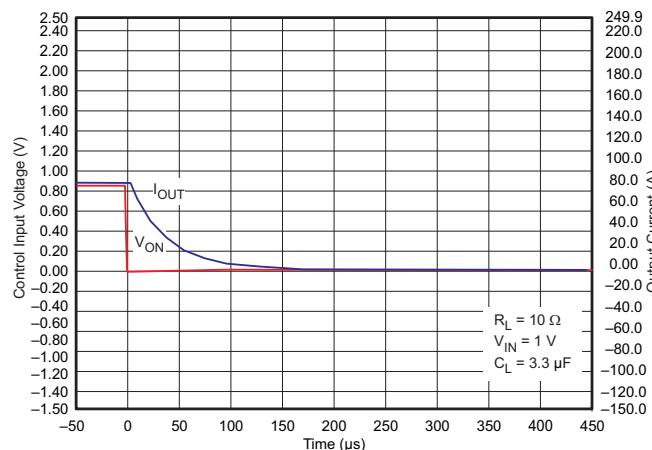
Figure 31.  $t_{OFF}$  ResponseFigure 32.  $t_{OFF}$  ResponseFigure 33.  $t_{OFF}$  ResponseFigure 34.  $t_{OFF}$  Response

**TYPICAL CHARACTERISTICS (continued)**

**Figure 35.  $t_{OFF}$  Response**

**Figure 36.  $t_{OFF}$  Response**
**TPS22922B**

**Figure 37.  $t_{ON}$  Response**

**Figure 38.  $t_{ON}$  Response**

**Figure 39.  $t_{ON}$  Response**

**Figure 40.  $t_{ON}$  Response**

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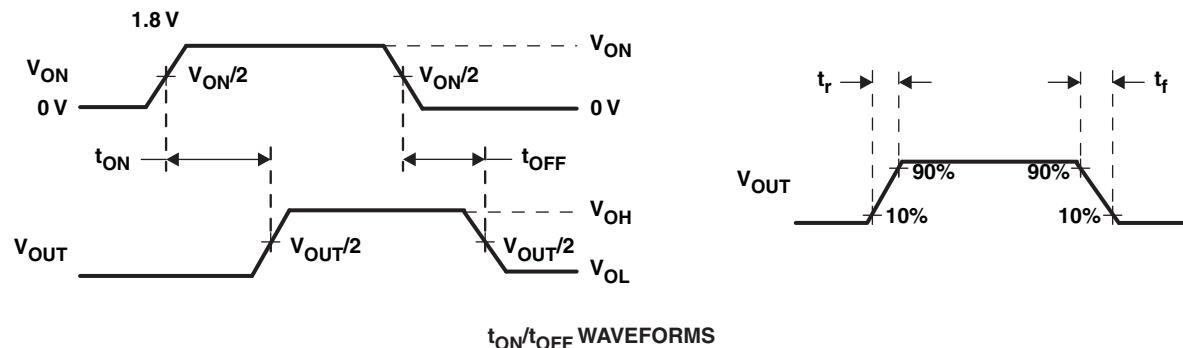
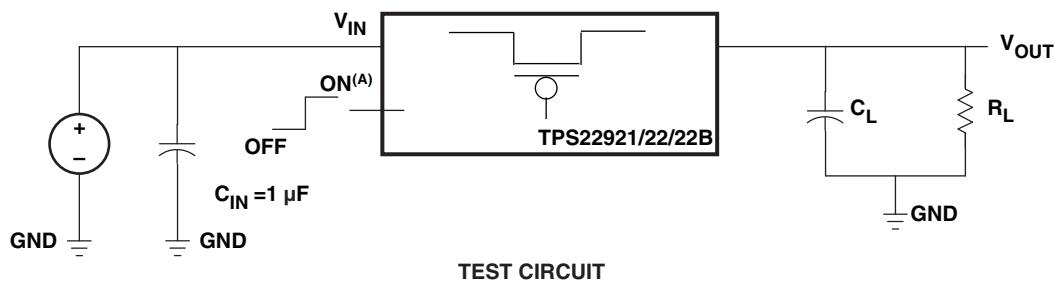
## TYPICAL CHARACTERISTICS (continued)

Figure 41.  $t_{ON}$  ResponseFigure 42.  $t_{ON}$  ResponseFigure 43.  $t_{ON}$  ResponseFigure 44.  $t_{ON}$  ResponseFigure 45.  $t_{OFF}$  ResponseFigure 46.  $t_{OFF}$  Response

**TYPICAL CHARACTERISTICS (continued)**

**Figure 47.  $t_{OFF}$  Response**

**Figure 48.  $t_{OFF}$  Response**

**Figure 49.  $t_{OFF}$  Response**

**Figure 50.  $t_{OFF}$  Response**

**Figure 51.  $t_{OFF}$  Response**

**Figure 52.  $t_{OFF}$  Response**

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## PARAMETER MEASUREMENT INFORMATION



A.  $t_{rise}$  and  $t_{fall}$  of the control signal is 100 ns.

**Figure 53. Test Circuit and  $t_{ON}/t_{OFF}$  Waveforms**

## APPLICATION INFORMATION

### ON/OFF Control

The ON pin controls the state of the switch. Activating ON continuously holds the switch in the on state so long as there is no fault. ON is active HI and has a low threshold making it capable of interfacing with low voltage signals. The ON pin is compatible with standard GPIO logic threshold. It can be used with any microcontroller with 1.2-V, 1.8-V, 2.5-V or 3.3-V GPIOs.

### Input Capacitor

To limit the voltage drop on the input supply caused by transient in-rush currents when the switch turns on into a discharged load capacitor or short-circuit, a capacitor must be placed between  $V_{IN}$  and GND. A 1- $\mu$ F ceramic capacitor,  $C_{IN}$ , placed close to the pins is usually sufficient. Higher values of  $C_{IN}$  can be used to further reduce the voltage drop during higher current application. When switching a heavy load, it is recommended to have an input capacitor about 10 or more times higher than the output capacitor in order to avoid any supply drop.

### Output Capacitor

Due to the integral body diode in the PMOS switch, a  $C_{IN}$  greater than  $C_L$  is highly recommended. A  $C_L$  greater than  $C_{IN}$  can cause  $V_{OUT}$  to exceed  $V_{IN}$  when the system supply is removed. This could result in current flow through the body diode from  $V_{OUT}$  to  $V_{IN}$ .

### Board Layout

For best performance, all traces should be as short as possible. To be most effective, the input and output capacitors should be placed close to the device to minimize the effects that parasitic trace inductances may have on normal and short-circuit operation. Using wide traces for  $V_{IN}$ ,  $V_{OUT}$ , and GND will help minimize the parasitic electrical effects along with minimizing the case to ambient thermal impedance.

**PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
TPS22921YFPR	ACTIVE	DSBGA	YFP	6	3000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM
TPS22921YZPR	ACTIVE	DSBGA	YZP	6	3000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM
TPS22922BYFPR	ACTIVE	DSBGA	YFP	6	3000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM
TPS22922BYZPR	ACTIVE	DSBGA	YZP	6	3000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM
TPS22922YFPR	ACTIVE	DSBGA	YFP	6	3000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM
TPS22922YZPR	ACTIVE	DSBGA	YZP	6	3000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

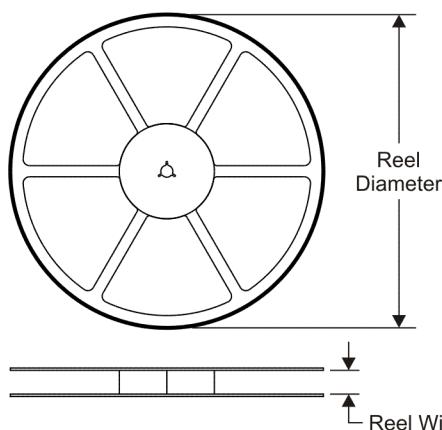
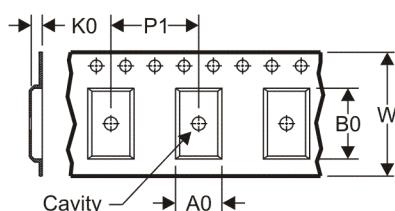
<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

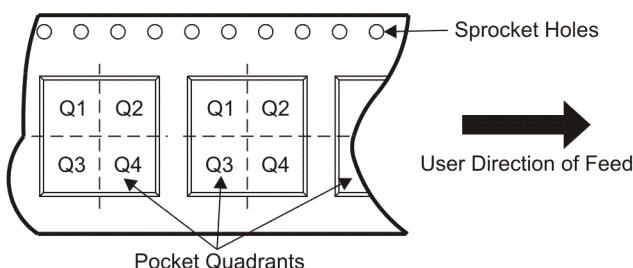
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21-Oct-2010

**TAPE AND REEL INFORMATION**
**REEL DIMENSIONS**

**TAPE DIMENSIONS**


A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

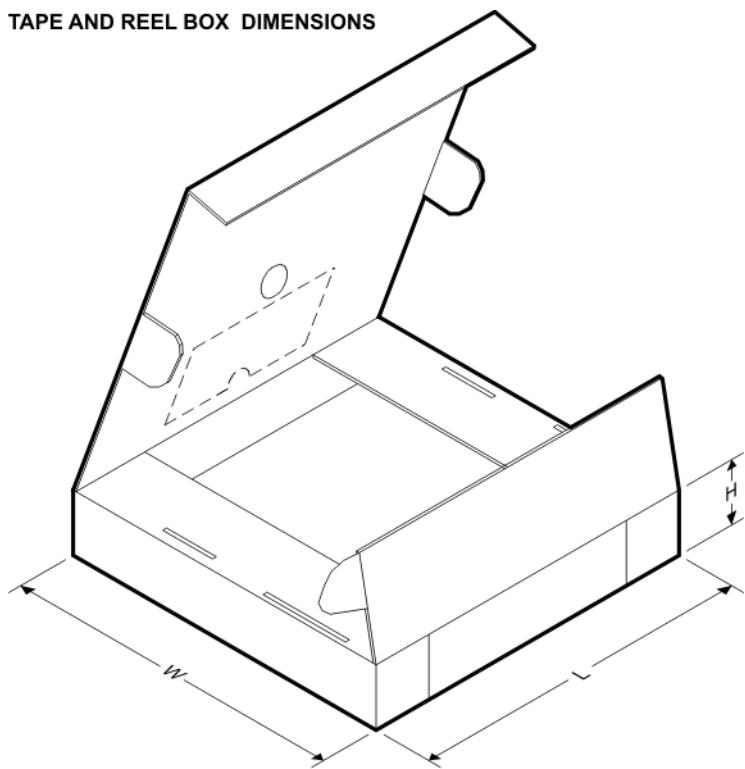
**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS22921YFPR	DSBGA	YFP	6	3000	180.0	8.4	0.89	1.29	0.62	4.0	8.0	Q1
TPS22921YFPR	DSBGA	YFP	6	3000	180.0	8.4	0.89	1.29	0.62	4.0	8.0	Q1
TPS22921YZPR	DSBGA	YZP	6	3000	180.0	8.4	1.02	1.52	0.63	4.0	8.0	Q1
TPS22922BYFPR	DSBGA	YFP	6	3000	180.0	8.4	0.89	1.29	0.62	4.0	8.0	Q1
TPS22922BYZPR	DSBGA	YZP	6	3000	180.0	8.4	1.02	1.52	0.63	4.0	8.0	Q1
TPS22922YFPR	DSBGA	YFP	6	3000	180.0	8.4	0.89	1.29	0.62	4.0	8.0	Q1
TPS22922YZPR	DSBGA	YZP	6	3000	180.0	8.4	1.02	1.52	0.63	4.0	8.0	Q1

[查询"TPS22921"供应商](http://www.ti.com)

21-Oct-2010

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

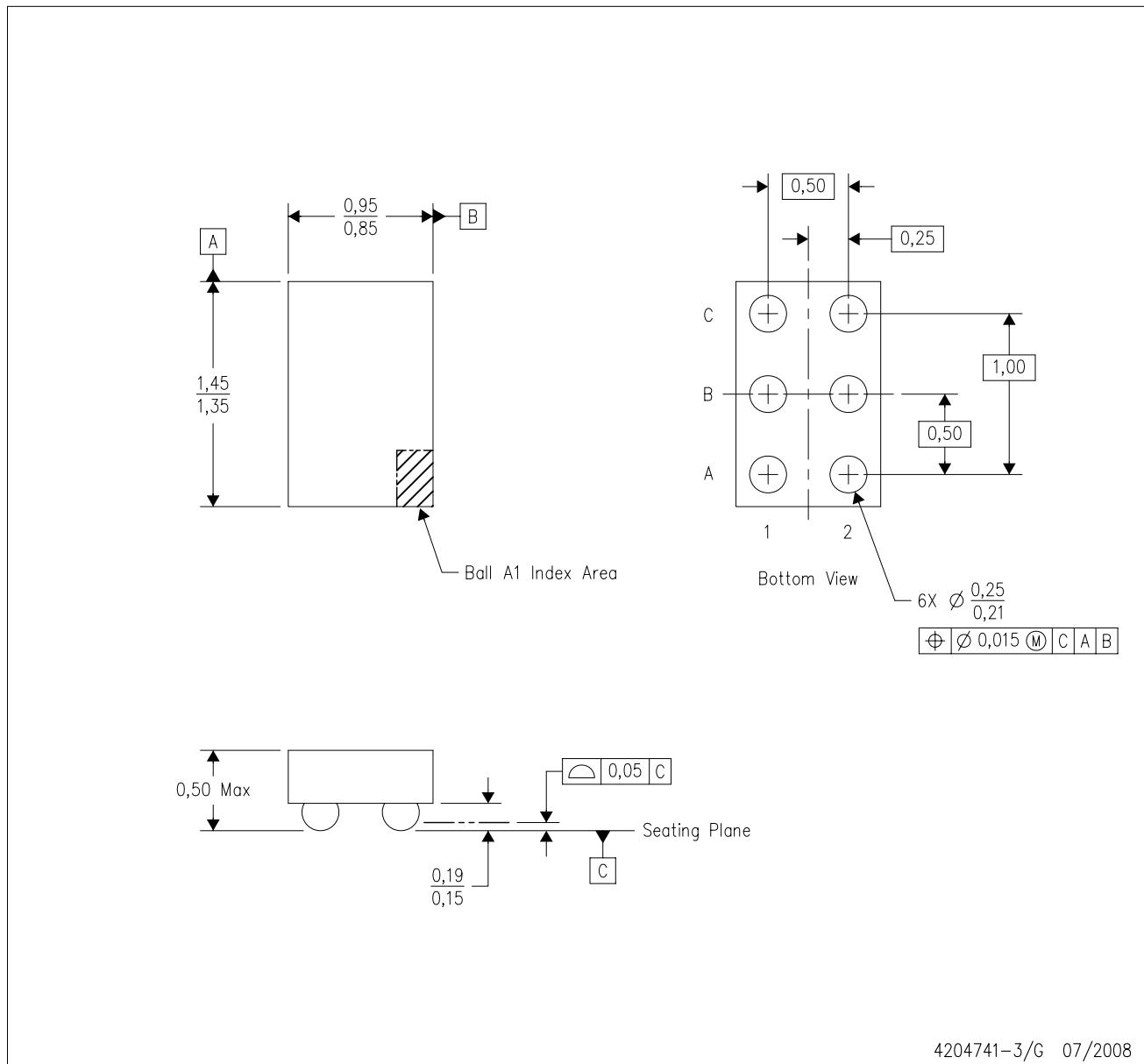
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS22921YFPR	DSBGA	YFP	6	3000	220.0	220.0	34.0
TPS22921YFPR	DSBGA	YFP	6	3000	190.5	212.7	31.8
TPS22921YZPR	DSBGA	YZP	6	3000	220.0	220.0	34.0
TPS22922BYFPR	DSBGA	YFP	6	3000	220.0	220.0	34.0
TPS22922BYZPR	DSBGA	YZP	6	3000	220.0	220.0	34.0
TPS22922YFPR	DSBGA	YFP	6	3000	220.0	220.0	34.0
TPS22922YZPR	DSBGA	YZP	6	3000	220.0	220.0	34.0

## MECHANICAL DATA

[查询"TPS22921"供应商](#)

YZP (R-XBGA-N6)

DIE-SIZE BALL GRID ARRAY



4204741-3/G 07/2008

- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. NanoFree™ package configuration.
  - D. This package is lead-free. Refer to the 6 YEP package (drawing 4204725) for tin-lead (SnPb).

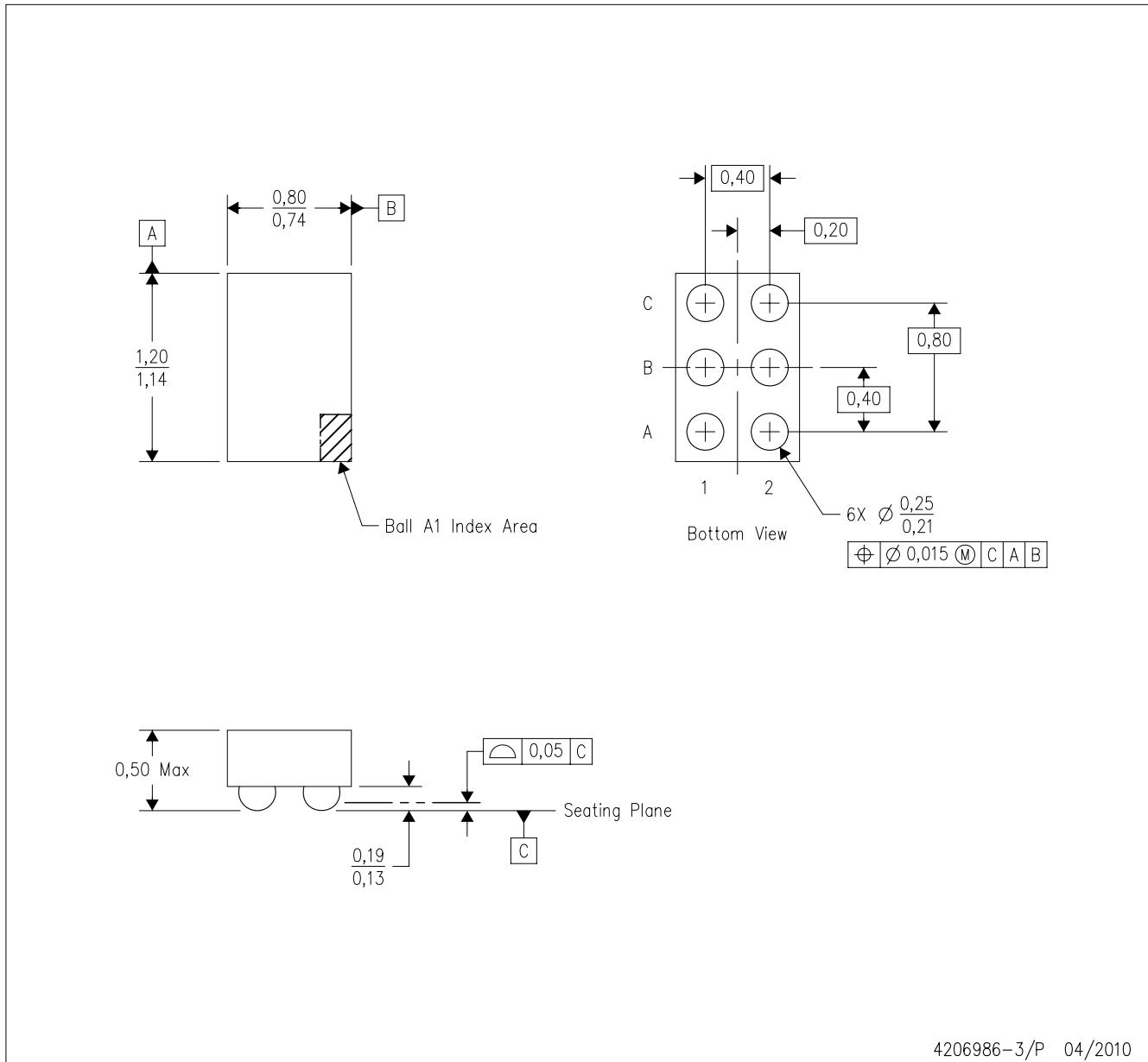
NanoFree is a trademark of Texas Instruments.

## MECHANICAL DATA

[查询"TPS22921"供应商](#)

YFP (R-XBGA-N6)

DIE-SIZE BALL GRID ARRAY



4206986-3/P 04/2010

- NOTES:
- All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - This drawing is subject to change without notice.
  - NanoFree™ package configuration.
  - This is a Pb-free solder ball design.

NanoFree is a trademark of Texas Instruments.

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Interface	<a href="http://interface.ti.com">interface.ti.com</a>	Energy	<a href="http://www(ti.com/energy">www(ti.com/energy</a>
Logic	<a href="http://logic.ti.com">logic.ti.com</a>	Industrial	<a href="http://www(ti.com/industrial">www(ti.com/industrial</a>
Power Mgmt	<a href="http://power.ti.com">power.ti.com</a>	Medical	<a href="http://www(ti.com/medical">www(ti.com/medical</a>
Microcontrollers	<a href="http://microcontroller.ti.com">microcontroller.ti.com</a>	Security	<a href="http://www(ti.com/security">www(ti.com/security</a>
RFID	<a href="http://www(ti-rfid.com">www(ti-rfid.com</a>	Space, Avionics & Defense	<a href="http://www(ti.com/space-avionics-defense">www(ti.com/space-avionics-defense</a>
RF/IF and ZigBee® Solutions	<a href="http://www(ti.com/lprf">www(ti.com/lprf</a>	Video and Imaging	<a href="http://www(ti.com/video">www(ti.com/video</a>
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